

ACCUTEK
MICROCIRCUIT CORPORATION

AK63264W/AK63264Z 64K x 32 SRAM MODULE

DESCRIPTION

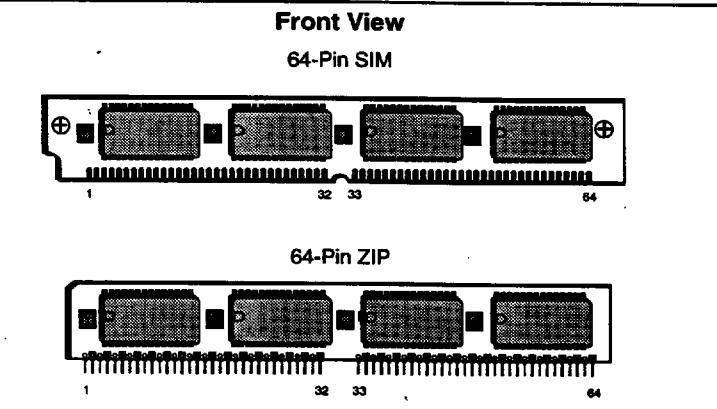
The Accutek AK63264 SRAM Module consists of fast high performance SRAMs mounted on a low profile, 64 pin SIM or ZIP Board. The module utilizes four 28 pin 64K x 4 SRAMs in SOJ packages and four decoupling capacitors on each side of a printed circuit board.

The SRAMs used have common I/O functions and single output enable functions. Also, four separate chip select (CE) connections are used to independently enable the four bytes. The modules can be supplied in a variety of access time values from 12 nSEC to 45 nSEC in CMOS or BiCMOS technology.

The Accutek module is designed to have a maximum seated height of 0.600 inch SIM or 0.500 inch ZIP to provide for the lowest height off the board. By offset-mounting the back surface SRAMs on the SIM version the module can be mounted in either angled or straight-up SIM sockets. Each conforms to JEDEC - standard sizes and pin-out configurations. Using two pins for module memory density identification, PDo and PD₁, minimizes interchangeability and design considerations when changing from one module size to the other in customer applications.

FEATURES

- 65,536 x 32 bit organization
- JEDEC Standard 64 pin SIM or ZIP format
- Common I/O, single \overline{OE} functions with four separate chip selects (CE)
- Low height, 0.600 inch SIM or 0.500 inch ZIP maximum



- Upward compatible with 128K x 32 (AK632128), 256K x 32 (AK632256) and 1 Meg x 32 (AK6321024) designs
- Presence Detect, PDo and PD₁ for identifying module density
- Fast Access Times range from 12 nSEC BiCMOS to 45 nSEC CMOS
- TTL-compatible inputs and outputs
- Single +5 Volt ($\pm 10\%$) power supply
- Operating temperature range in free air, 0°C to 70°C

ELECTRICAL SPECIFICATIONS

Timing diagrams and basic electrical characteristics are those of the standard 64K x 4 SRAMs used to construct these modules. Accutek's module design allows the flexibility of selecting industry-compatible 64K x 4 SRAMs from at least seven semiconductor manufacturers.

PIN NOMENCLATURE		PIN ASSIGNMENT								FUNCTIONAL DIAGRAM			
A ₀ - A ₁₅	Address Inputs	PIN #	SYMBOL	PIN #	SYMBOL	PIN #	SYMBOL	PIN #	SYMBOL				
CE ₁ - CE ₄	Chip Enable	1	V _{SS}	17	A ₂	33	CE ₄	49	A ₄				
DQ ₁ - DQ ₃₂	Data In/Data Out	2	PDo	18	A ₈	34	CE ₃	50	A ₁₁				
OE	Output Enable	3	PD ₁	19	DQ ₁₃	35	NC	51	A ₅				
PDo - PD ₁	Presence Detect	4	DQ ₁	20	DQ ₅	36	NC	52	A ₁₂				
Vcc	5v Supply	5	DQ ₉	21	DQ ₁₄	37	OE	53	V _{CC}				
Vss	Ground	6	DQ ₂	22	DQ ₆	38	V _{SS}	54	A ₁₃				
WE	Write Enable	7	DQ ₁₀	23	DQ ₁₅	39	DQ ₂₅	55	A ₆				
		8	DQ ₃	24	DQ ₇	40	DQ ₁₇	56	DQ ₂₁				
		9	DQ ₁₁	25	DQ ₁₆	41	DQ ₂₆	57	DQ ₂₉				
		10	DQ ₄	26	DQ ₈	42	DQ ₁₈	58	DQ ₂₂				
		11	DQ ₁₂	27	V _{SS}	43	DQ ₂₇	59	DQ ₃₀				
		12	V _{CC}	28	WE	44	DQ ₁₉	60	DQ ₂₃				
		13	A ₀	29	A ₁₆	45	DQ ₂₈	61	DQ ₃₁				
		14	A ₇	30	A ₁₄	46	DQ ₂₀	62	DQ ₂₄				
		15	A ₁	31	CE ₂	47	A ₃	63	DQ ₃₂				
		16	A ₈	32	CE ₁	48	A ₁₀	64	V _{SS}				
PD ₀ = Open PD ₁ = V _{SS}													
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MODULE OPTIONS

Leadless SIM: AK63264W

Leaded SIP: AK63264G

Leaded ZIP: AK63264Z

PD₀ = Open
PD₁ = V_{SS}

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ORDER INFORMATION

PART NUMBER CODING INTERPRETATION

Position

1 2 3 4 5 6 7 8

1 Product

AK = Accutek Memory

2 Type

4 = Dynamic RAM
5 = CMOS Dynamic RAM
6 = Static RAM

3 Organization/Word Width

1 = b y 1 16 = by 16
4 = by 4 32 = by 32
8 = by 8 36 = by 36
9 = by 9

4 Size/Bits Depth

64 = 64K 4096 = 4 MEG
256 = 256K 8192 = 8 MEG
1024 = 1 MEG 16384 = 16 MEG

5 Package Type

G = Single In-Line Package (SIP)
S = Single In-Line Module (SIM)
D = Dual In-Line Package (DIP)
W = .050 inch Pitch Edge Connect
Z = Zig-Zag In-Line Package (ZIP)

6 Special Designation

P = Page Mode
N = Nibble Mode
K = Static Column Mode
W = Write Per Bit Mode
V = Video Ram

7 Separator

- = Commercial 0°C to +70°C
M = Military Equivalent Screened
(-55°C to +125°C)
I = Industrial Temperature Tested
(-45°C to +85°C)
X = Burned In

8 Speed (first two significant digits)

DRAMs	SRAMs		
60	= 60 nS	12	= 12 nS
70	= 70 nS	20	= 20 nS
80	= 80 nS	25	= 25 nS
10	= 100 nS	35	= 35 nS

The numbers and coding on this page do not include all variations available but are shown as examples of the most widely used variations. Contact Accutek if other information is required.

EXAMPLES:

AK63264W-25

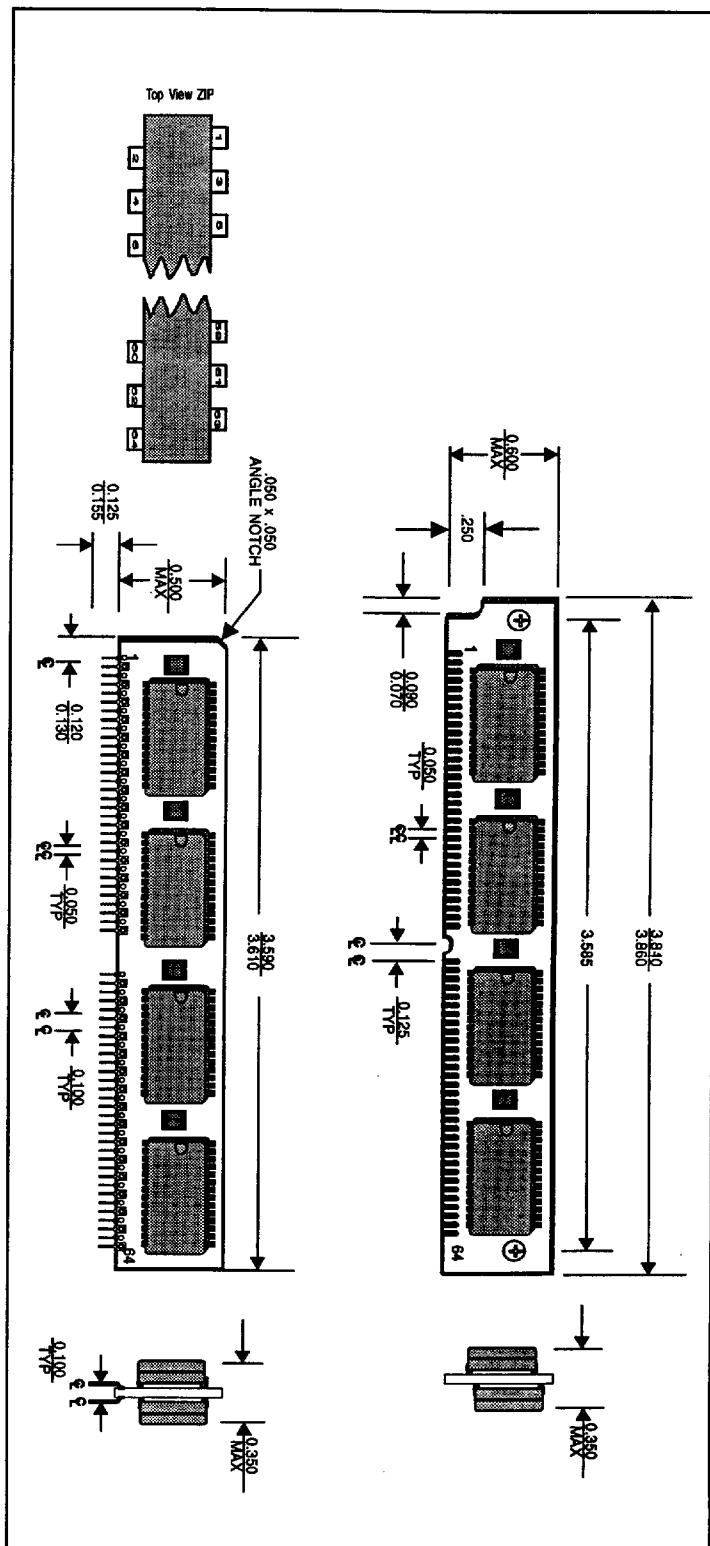
64K x 32, 25 nSEC SRAM Module, SIM Configuration

AK63264Z-12

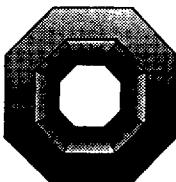
64K x 32, 12 nSEC SRAM Module, ZIP Configuration

MECHANICAL DIMENSIONS

Inches



Accutek Reserves the right to make changes in specifications at any time and without notice. Accutek does not assume any responsibility for the use of any circuitry described; no circuit patent licenses are implied. Preliminary data sheets contain minimum and maximum limits based upon design objectives, which are subject to change upon full characterization over the specific operating conditions.



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